

Abstracts

An 18 GHz Si bipolar mold package prescaler (1998 [RFIC])

M. Mineo, M. Okamoto, K. Hosoki and H. Ohba. "An 18 GHz Si bipolar mold package prescaler (1998 [RFIC])." 1998 Radio Frequency Integrated Circuits (RFIC) Symposium 98. (1998 [RFIC]): 213-216.

A mold package static prescaler operating at 18 GHz has been realized. The technology used is the Si bipolar process of which the emitter mask width is 0.8 μm . The cut-off frequency and the maximum oscillation frequency are 30 GHz and 40 GHz respectively. The input power range of operations is more than 10 dB in -70 to +95/spl deg/C at 1 to 15 GHz. This prescaler features a +5 V single supply voltage and 190 mW power dissipation.

 [Return to main document.](#)